

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	90	W	8/20μs, Per Figure 2
Peak Pulse Current	I <sub>PP</sub>	3	A	8/20μs, Per Figure 2
ESD Protection – Contact Discharge	V <sub>ESD Contact</sub>	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V <sub>ESD Air</sub>	±30	kV	Standard IEC 61000-4-2

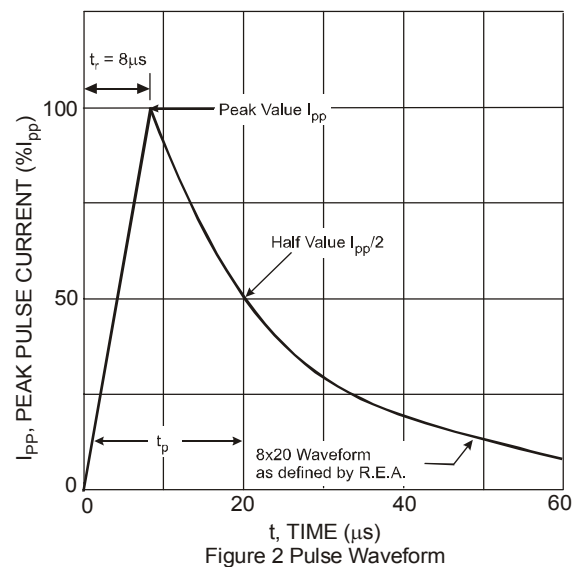
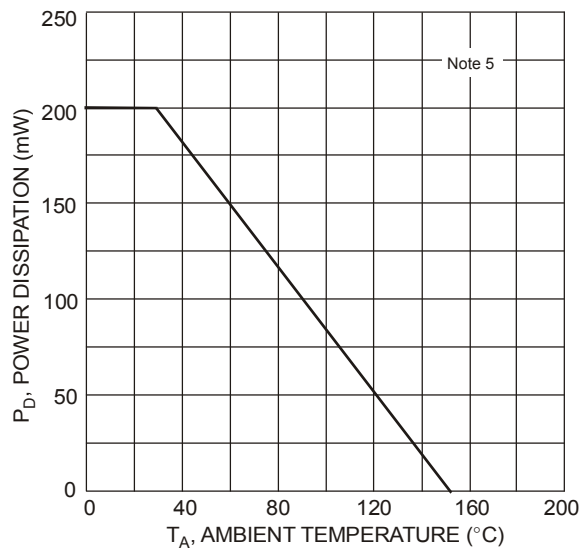
**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P <sub>D</sub>	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V <sub>RWM</sub>	—	—	20	V	—
Channel Leakage Current (Note 6)	I <sub>RM</sub>	—	—	100	nA	V <sub>RWM</sub> = 20V
Clamping Voltage, Positive Transients	V <sub>CL</sub>	—	—	27	V	I <sub>PP</sub> = 1A, t <sub>p</sub> = 8/20μs
		—	—	30	V	I <sub>PP</sub> = 3A, t <sub>p</sub> = 8/20μs
Breakdown Voltage	V <sub>BR</sub>	21	—	25	V	I <sub>R</sub> = 1mA
Differential Resistance	R <sub>DIF</sub>	—	1.8	—	Ω	I <sub>R</sub> = 1A, t <sub>p</sub> = 8/20μs
Channel Input Capacitance	C <sub>T</sub>	—	10	15	pF	V <sub>R</sub> = 0V, f = 1MHz

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
  - Short duration pulse test used to minimize self-heating effect.



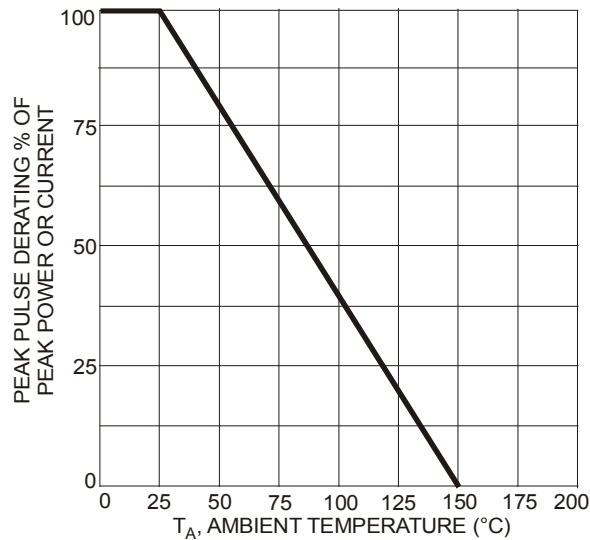


Figure 3 Power Dissipation vs. Ambient Temperature

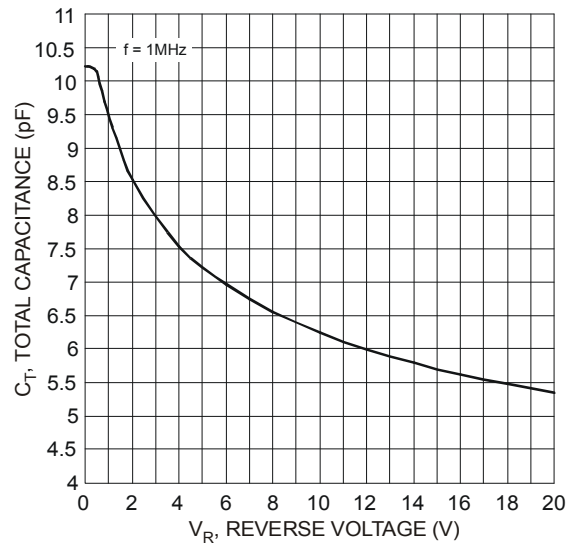


Figure 4 Typical Total Capacitance vs. Reverse Voltage

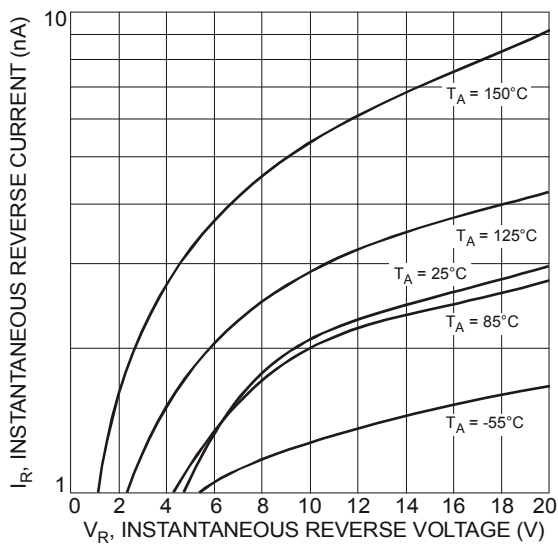
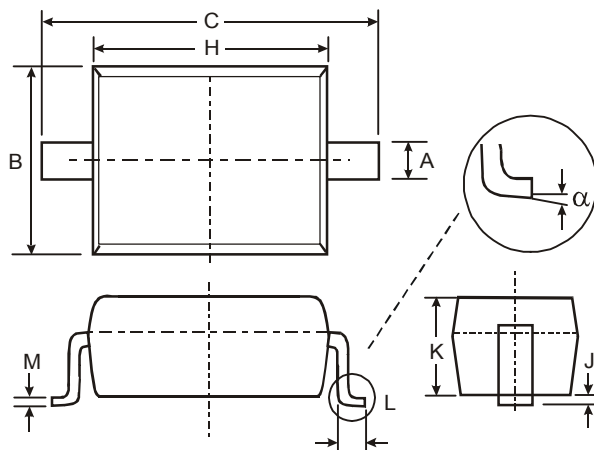


Figure 5 Typical Reverse Characteristics

## Package Outline Dimensions

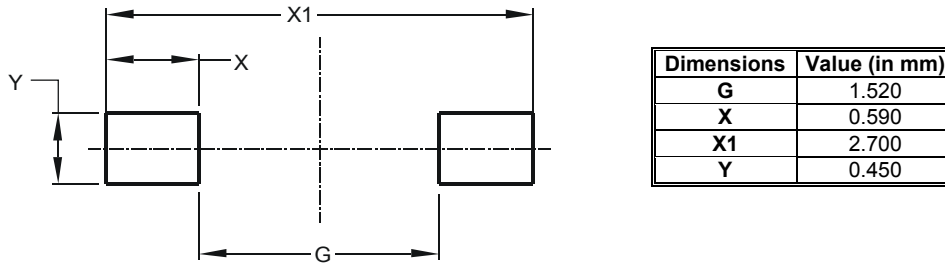
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOD323		
Dim	Min	Max
A	0.25	0.35
B	1.20	1.40
C	2.30	2.70
H	1.60	1.80
J	0.00	0.10
K	1.0	1.1
L	0.20	0.40
M	0.10	0.15
$\alpha$	0°	8°
All Dimensions in mm		

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



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